



MONTH	COVER STORY	FEATURE 1	FEATURE 2	FEATURE 3
JANUARY	FPGAs & ASICs	Power supplies & Batteries	AC-DC/DC-DC converters	Recruitment
FEBRUARY	Displays & LEDs	Analogue IC's	Crystals/Oscillators	Optoelectronics
MARCH	Chip-to-chip interconnection	Soldering	Enclosures	Education & Training
APRIL	EMI/EMC filters & filtering	Machine vision	Sensors/actuators	Automobile electronics
MAY	Computers & peripherals	Memory chips/modules <i>Extra circulation at Austronics/National Manufacturing Week (12-15 May, Melbourne)</i>	Motors/motion control	Electronic distributors
JUNE	Solar energy systems	Contract manufacturing	Wafer fabrication	Consumer electronics
JULY	Embedded computing	Design tools	Programmable logic	Data acquisition
AUGUST	Microwave, RF components & wireless	Memory developments	Thermal management	Medical electronics
SEPTEMBER	Microprocessors/Microcontrollers	Digital IC's	Nanotechnology	Security electronics
OCTOBER	Test & measurement	Connectors & interconnection	Transistors / Solid state switches	Avionics & military electronics
NOVEMBER	Circuit design/ PCB assembly	Ethernet	Capacitors/resistors	Asia in focus
DECEMBER	Power management	Development kits	Digital power	Offshoring

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